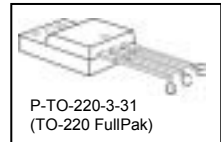
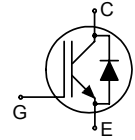


Low Loss DuoPack : IGBT in **TrenchStop®** and Fieldstop technology  
with soft, fast recovery anti-parallel EmCon HE diode

- Very low  $V_{CE(sat)}$  1.5 V (typ.)
- Maximum Junction Temperature 175 °C
- Short circuit withstand time – 5µs
- **TrenchStop®** and Fieldstop technology for 600 V applications offers :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - very high switching speed
- Positive temperature coefficient in  $V_{CE(sat)}$
- Low EMI
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



### Applications:

- Air Condition
- Inverters

| Type      | $V_{CE}$ | $I_C$ | $V_{CE(sat)}, T_j=25^\circ\text{C}$ | $T_{j,max}$ | Marking Code | Package       |
|-----------|----------|-------|-------------------------------------|-------------|--------------|---------------|
| IKA15N60T | 600V     | 15A   | 1.5V                                | 175°C       | K15T60       | P-TO-220-3-31 |

### Maximum Ratings

| Parameter                                                                                                                      | Symbol       | Value       | Unit      |
|--------------------------------------------------------------------------------------------------------------------------------|--------------|-------------|-----------|
| Collector-emitter voltage                                                                                                      | $V_{CE}$     | 600         | V         |
| DC collector current, limited by $T_{j,max}$<br>$T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$                          | $I_C$        | 14.7<br>8.9 | A         |
| Pulsed collector current, $t_p$ limited by $T_{j,max}$                                                                         | $I_{C,puls}$ | 45          |           |
| Turn off safe operating area ( $V_{CE} \leq 600\text{V}$ , $T_j \leq 175^\circ\text{C}$ )                                      | -            | 45          |           |
| Diode forward current, limited by $T_{j,max}$<br>$T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$                         | $I_F$        | 15.5<br>9   |           |
| Diode pulsed current, $t_p$ limited by $T_{j,max}$                                                                             | $I_{F,puls}$ | 45          |           |
| Gate-emitter voltage                                                                                                           | $V_{GE}$     | $\pm 20$    | V         |
| Short circuit withstand time <sup>2)</sup><br>$V_{GE} = 15\text{V}$ , $V_{CC} \leq 400\text{V}$ , $T_j \leq 150^\circ\text{C}$ | $t_{SC}$     | 5           | µs        |
| Power dissipation $T_C = 25^\circ\text{C}$                                                                                     | $P_{tot}$    | 35.7        | W         |
| Operating junction temperature                                                                                                 | $T_j$        | -40...+175  | °C        |
| Storage temperature                                                                                                            | $T_{stg}$    | -55...+175  |           |
| Solder temperature<br>wavesoldering, 1.6 mm (0.063 in.) from case for 10s                                                      |              | 260         |           |
| Isolation Voltage                                                                                                              | $V_{isol}$   | 2500        | $V_{rms}$ |

<sup>1</sup> J-STD-020 and JESD-022

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

### Thermal Resistance

| Parameter                                    | Symbol      | Conditions | Max. Value | Unit |
|----------------------------------------------|-------------|------------|------------|------|
| <b>Characteristic</b>                        |             |            |            |      |
| IGBT thermal resistance,<br>junction – case  | $R_{thJC}$  |            | 4.2        | K/W  |
| Diode thermal resistance,<br>junction – case | $R_{thJCD}$ |            | 4.8        |      |
| Thermal resistance,<br>junction – ambient    | $R_{thJA}$  |            | 80         |      |

### Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                            | Symbol        | Conditions                              | Value  |             |            | Unit     |
|--------------------------------------|---------------|-----------------------------------------|--------|-------------|------------|----------|
|                                      |               |                                         | min.   | Typ.        | max.       |          |
| Static Characteristic                |               |                                         |        |             |            |          |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE}=0V, I_C=0.2mA$                  | 600    | -           | -          | V        |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $V_{GE} = 15V, I_C=15A$                 |        |             |            |          |
|                                      |               | $T_j=25^{\circ}C$<br>$T_j=175^{\circ}C$ | -<br>- | 1.5<br>1.9  | 2.05<br>-  |          |
| Diode forward voltage                | $V_F$         | $V_{GE}=0V, I_F=15A$                    |        |             |            |          |
|                                      |               | $T_j=25^{\circ}C$<br>$T_j=175^{\circ}C$ | -<br>- | 1.65<br>1.6 | 2.05<br>-  |          |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C=210\mu A, V_{CE}=V_{GE}$           | 4.1    | 4.9         | 5.7        |          |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE}=600V,$<br>$V_{GE}=0V$           |        |             |            | $\mu A$  |
|                                      |               | $T_j=25^{\circ}C$<br>$T_j=175^{\circ}C$ | -<br>- | -<br>-      | 40<br>1000 |          |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE}=0V, V_{GE}=20V$                 | -      | -           | 100        | nA       |
| Transconductance                     | $g_{fs}$      | $V_{CE}=20V, I_C=15A$                   | -      | 8.7         | -          | S        |
| Integrated gate resistor             | $R_{Gint}$    |                                         | -      |             |            | $\Omega$ |

### Dynamic Characteristic

|                                                                   |             |                                                                                     |   |       |   |    |
|-------------------------------------------------------------------|-------------|-------------------------------------------------------------------------------------|---|-------|---|----|
| Input capacitance                                                 | $C_{iss}$   | $V_{CE}=25V,$<br>$V_{GE}=0V,$<br>$f=1MHz$                                           | - | 860   | - | pF |
| Output capacitance                                                | $C_{oss}$   |                                                                                     | - | 55    | - |    |
| Reverse transfer capacitance                                      | $C_{rss}$   |                                                                                     | - | 24    | - |    |
| Gate charge                                                       | $Q_{Gate}$  | $V_{CC}=480V, I_C=15A$<br>$V_{GE}=15V$                                              | - | 87    | - | nC |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from case | $L_E$       |                                                                                     | - | 7     | - | nH |
| Short circuit collector current <sup>1)</sup>                     | $I_{C(SC)}$ | $V_{GE}=15V, t_{SC}\leq 5\mu s$<br>$V_{CC} = 400V,$<br>$T_j \leq 150^\circ\text{C}$ | - | 137.5 | - | A  |

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

### Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

| Parameter              | Symbol       | Conditions                                                                                                                                                                                  | Value |      |      | Unit |
|------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                        |              |                                                                                                                                                                                             | min.  | Typ. | max. |      |
| IGBT Characteristic    |              |                                                                                                                                                                                             |       |      |      |      |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=25^{\circ}\text{C}$ ,<br>$V_{CC}=400\text{V}$ , $I_C=15\text{A}$ ,<br>$V_{GE}=0/15\text{V}$ ,<br>$R_G=15\Omega$ ,<br>$L_{\sigma}^{1)}=154\text{nH}$ ,<br>$C_{\sigma}^{1)}=39\text{pF}$ | -     | 17   | -    | ns   |
| Rise time              | $t_r$        |                                                                                                                                                                                             | -     | 11   | -    |      |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                             | -     | 188  | -    |      |
| Fall time              | $t_f$        |                                                                                                                                                                                             | -     | 50   | -    |      |
| Turn-on energy         | $E_{on}$     | Energy losses include<br>“tail” and diode<br>reverse recovery.                                                                                                                              | -     | 0.22 | -    | mJ   |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                             | -     | 0.35 | -    |      |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                             | -     | 0.57 | -    |      |

### Anti-Parallel Diode Characteristic

|                                                                  |              |                                                                                                         |   |      |   |                        |
|------------------------------------------------------------------|--------------|---------------------------------------------------------------------------------------------------------|---|------|---|------------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_j=25^\circ\text{C}$ ,<br>$V_R=400\text{V}$ , $I_F=15\text{A}$ ,<br>$di_F/dt=825\text{A}/\mu\text{s}$ | - | 34   | - | ns                     |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                         | - | 0.24 | - | $\mu\text{C}$          |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                         | - | 10.4 | - | A                      |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |                                                                                                         | - | 718  | - | $\text{A}/\mu\text{s}$ |

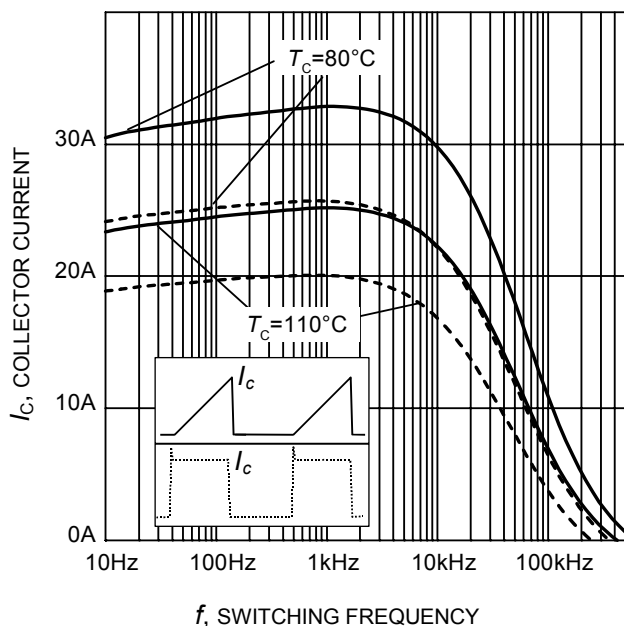
### Switching Characteristic, Inductive Load, at $T_j=175^\circ\text{C}$

| Parameter              | Symbol       | Conditions                                                                                                                                                                                                                                        | Value |      |      | Unit |
|------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                        |              |                                                                                                                                                                                                                                                   | min.  | Typ. | max. |      |
| IGBT Characteristic    |              |                                                                                                                                                                                                                                                   |       |      |      |      |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=175^{\circ}\text{C}$ ,<br>$V_{CC}=400\text{V}$ , $I_C=15\text{A}$ ,<br>$V_{GE}=0/15\text{V}$ ,<br>$R_G=15\ \Omega$<br>$L_{\sigma}^{1)}$ =154nH,<br>$C_{\sigma}^{1)}$ =39pF<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -     | 17   | -    | ns   |
| Rise time              | $t_r$        |                                                                                                                                                                                                                                                   | -     | 15   | -    |      |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                                                                                   | -     | 212  | -    |      |
| Fall time              | $t_f$        |                                                                                                                                                                                                                                                   | -     | 79   | -    |      |
| Turn-on energy         | $E_{on}$     |                                                                                                                                                                                                                                                   | -     | 0.34 | -    | mJ   |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                                                                                   | -     | 0.47 | -    |      |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                                                                                   | -     | 0.81 | -    |      |

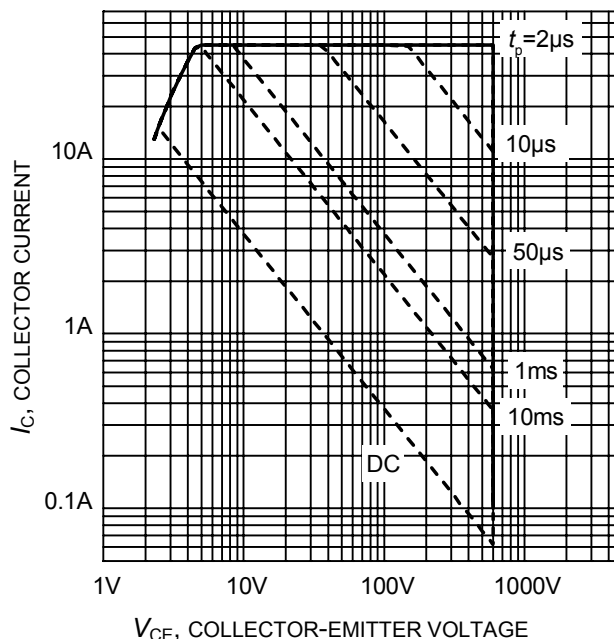
### Anti-Parallel Diode Characteristic

|                                                                  |              |                                                                                                          |   |      |   |                        |
|------------------------------------------------------------------|--------------|----------------------------------------------------------------------------------------------------------|---|------|---|------------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_j=175^\circ\text{C}$ ,<br>$V_R=400\text{V}$ , $I_F=15\text{A}$ ,<br>$di_F/dt=825\text{A}/\mu\text{s}$ | - | 140  | - | ns                     |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                          | - | 1.0  | - | $\mu\text{C}$          |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                          | - | 14.7 | - | A                      |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |                                                                                                          | - | 495  | - | $\text{A}/\mu\text{s}$ |

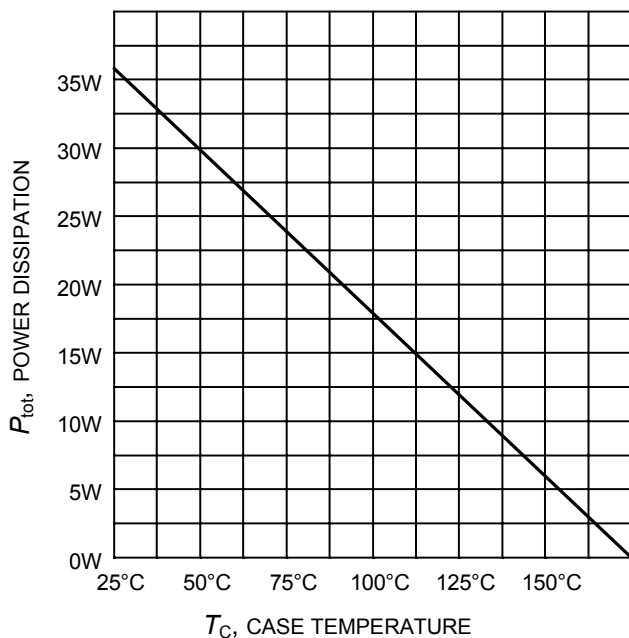
<sup>1)</sup> Leakage inductance  $L_{\sigma}$  and Stray capacity  $C_{\sigma}$  due to dynamic test circuit in Figure E.



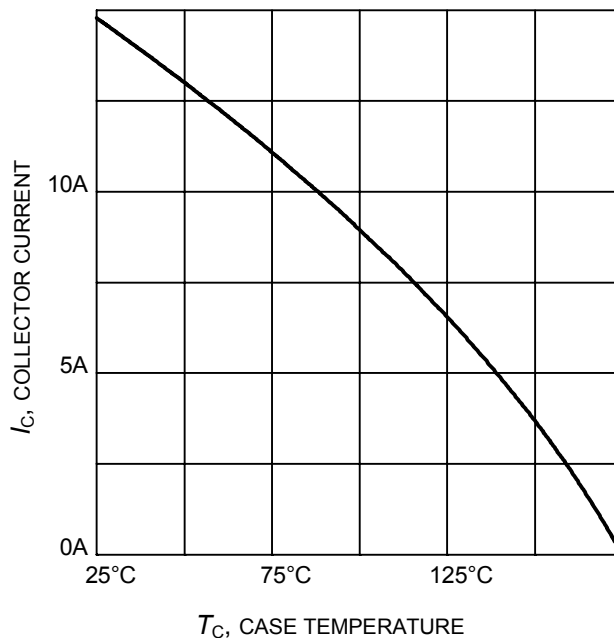
**Figure 1. Collector current as a function of switching frequency**  
 $(T_J \leq 175^\circ\text{C}, D = 0.5, V_{CE} = 400\text{V}, V_{GE} = 0/+15\text{V}, R_G = 15\Omega)$



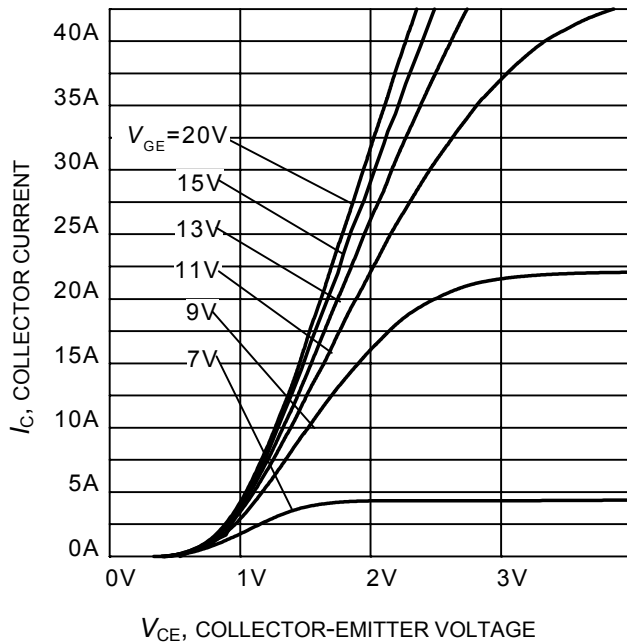
**Figure 2. Safe operating area**  
 $(D = 0, T_C = 25^\circ\text{C}, T_J \leq 175^\circ\text{C}; V_{GE} = 15\text{V})$



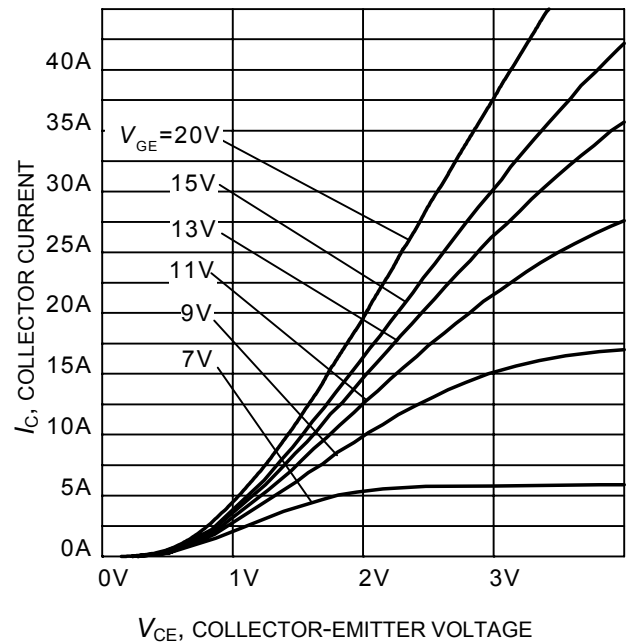
**Figure 3. Power dissipation as a function of case temperature**  
 $(T_J \leq 175^\circ\text{C})$



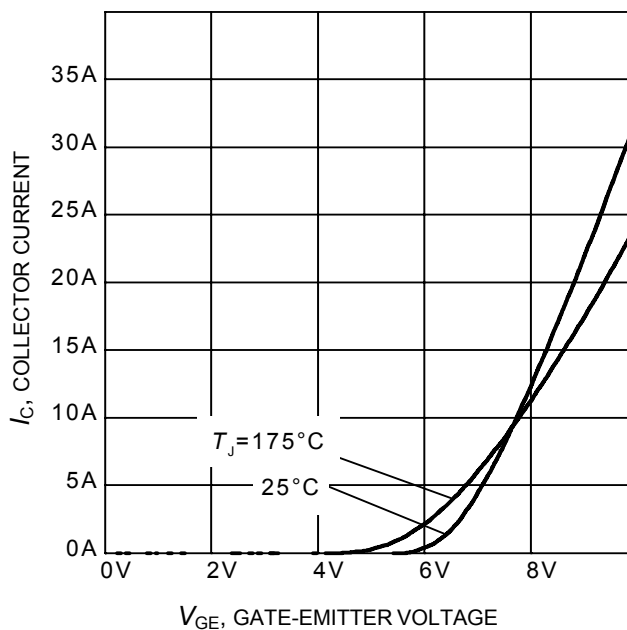
**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \geq 15\text{V}, T_J \leq 175^\circ\text{C})$



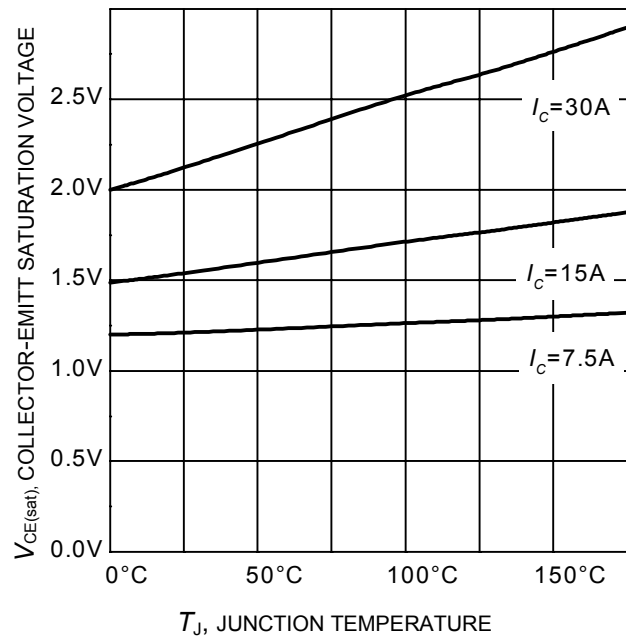
**Figure 5. Typical output characteristic**  
( $T_j = 25^\circ\text{C}$ )



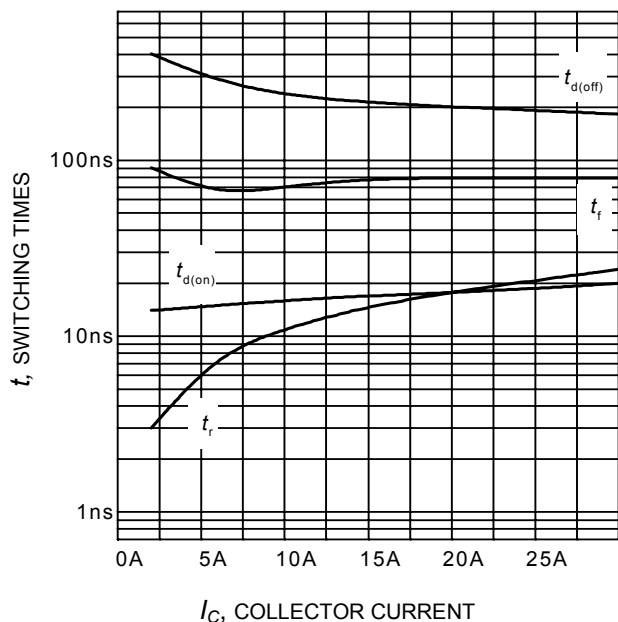
**Figure 6. Typical output characteristic**  
( $T_j = 175^\circ\text{C}$ )



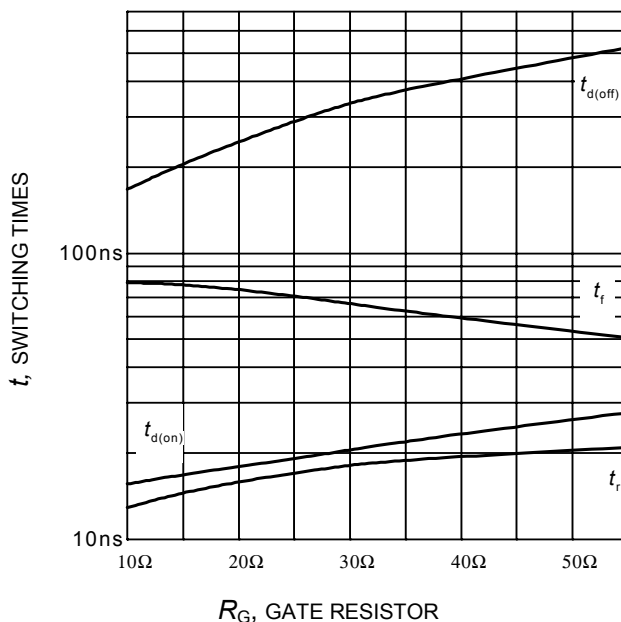
**Figure 7. Typical transfer characteristic**  
( $V_{ce} = 20\text{V}$ )



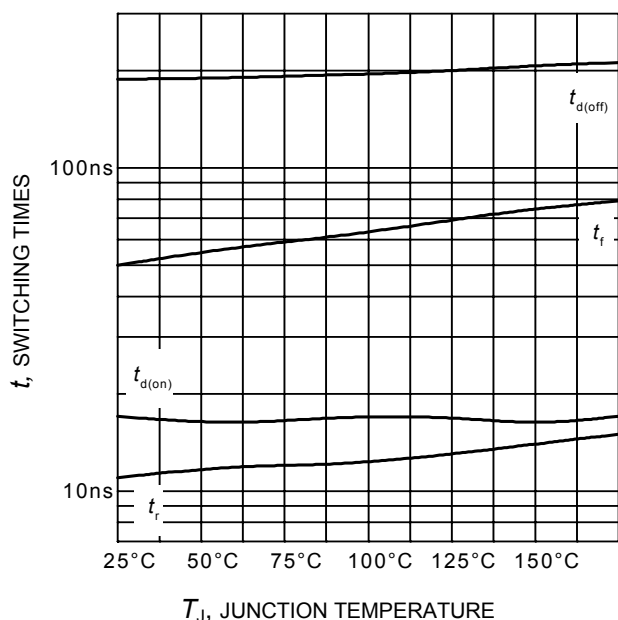
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{ge} = 15\text{V}$ )



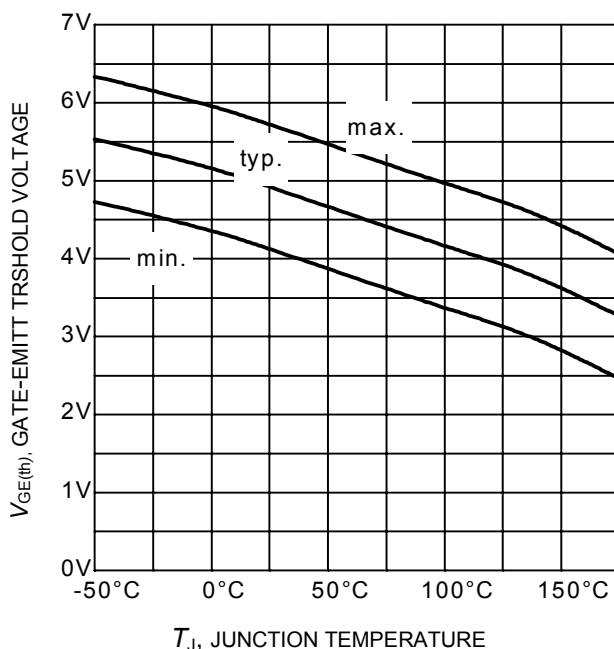
**Figure 9. Typical switching times as a function of collector current**  
(inductive load,  $T_J = 175^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $R_G = 15\Omega$ , Dynamic test circuit in Figure E)



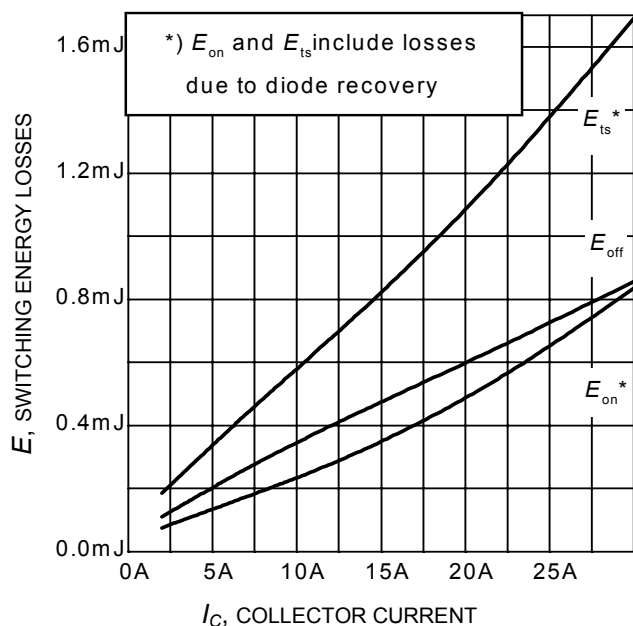
**Figure 10. Typical switching times as a function of gate resistor**  
(inductive load,  $T_J = 175^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $I_C = 15\text{A}$ , Dynamic test circuit in Figure E)



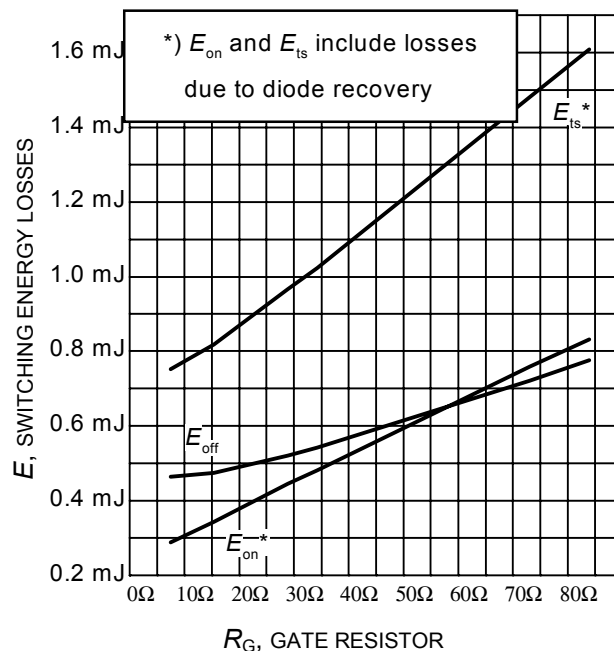
**Figure 11. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $I_C = 15\text{A}$ ,  $R_G = 15\Omega$ , Dynamic test circuit in Figure E)



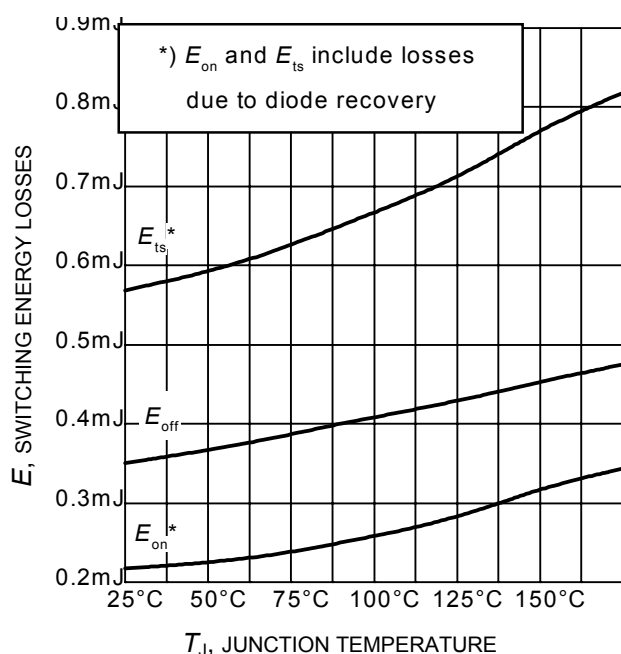
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C = 0.21\text{mA}$ )



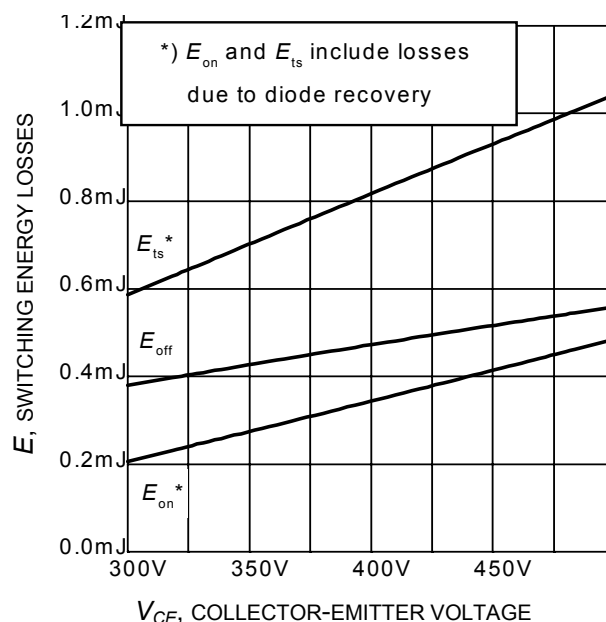
**Figure 13. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_J = 175^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $R_G = 15\Omega$ , Dynamic test circuit in Figure E)



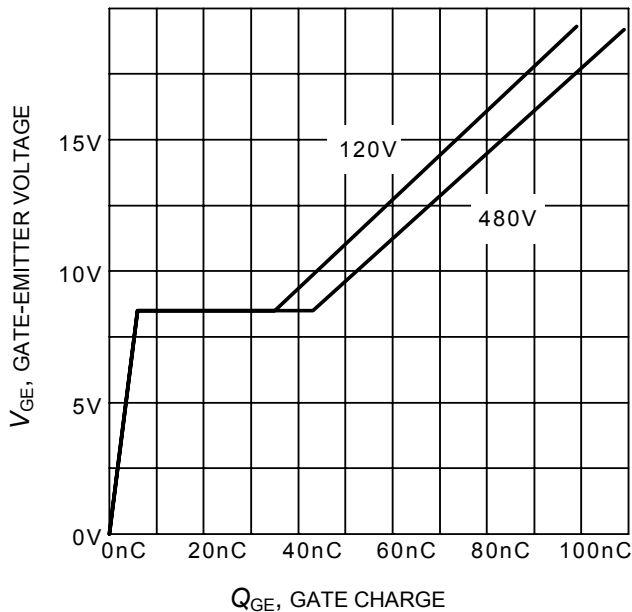
**Figure 14. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_J = 175^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $I_C = 15\text{A}$ , Dynamic test circuit in Figure E)



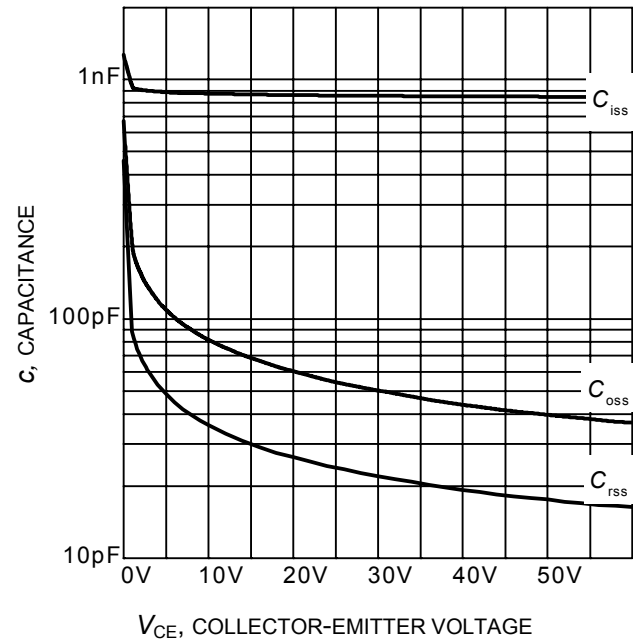
**Figure 15. Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $I_C = 15\text{A}$ ,  $R_G = 15\Omega$ , Dynamic test circuit in Figure E)



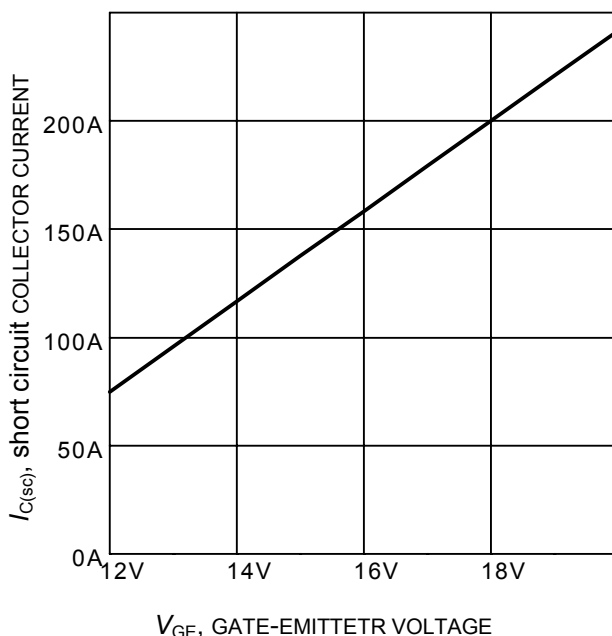
**Figure 16. Typical switching energy losses as a function of collector emitter voltage**  
(inductive load,  $T_J = 175^\circ\text{C}$ ,  $V_{GE} = 0/15\text{V}$ ,  $I_C = 15\text{A}$ ,  $R_G = 15\Omega$ , Dynamic test circuit in Figure E)



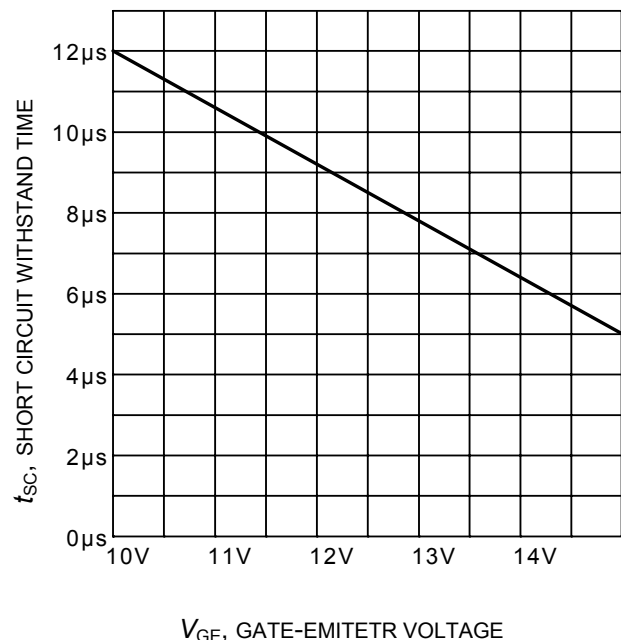
**Figure 17. Typical gate charge**  
( $I_C=15\text{ A}$ )



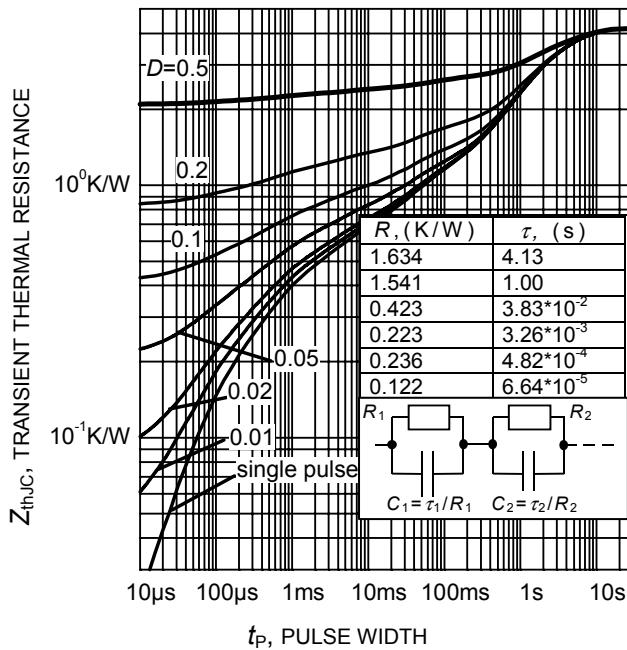
**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0\text{V}$ ,  $f = 1\text{ MHz}$ )



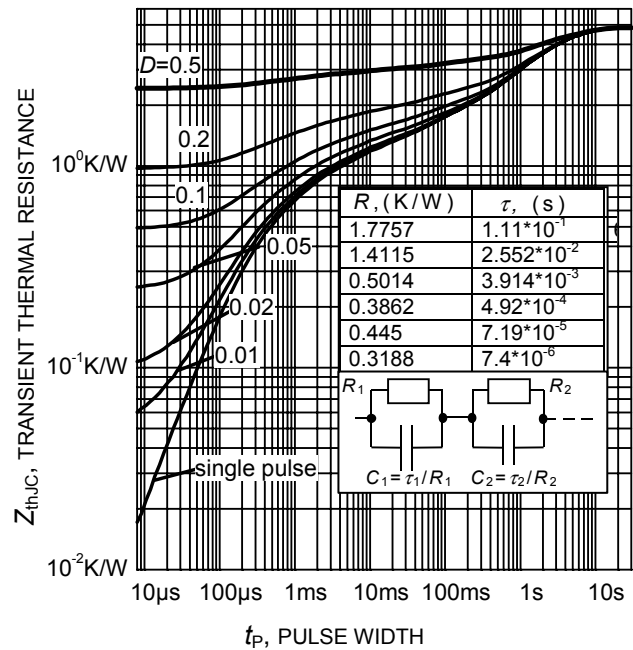
**Figure 19. Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 400\text{V}$ ,  $T_J \leq 150^\circ\text{C}$ )



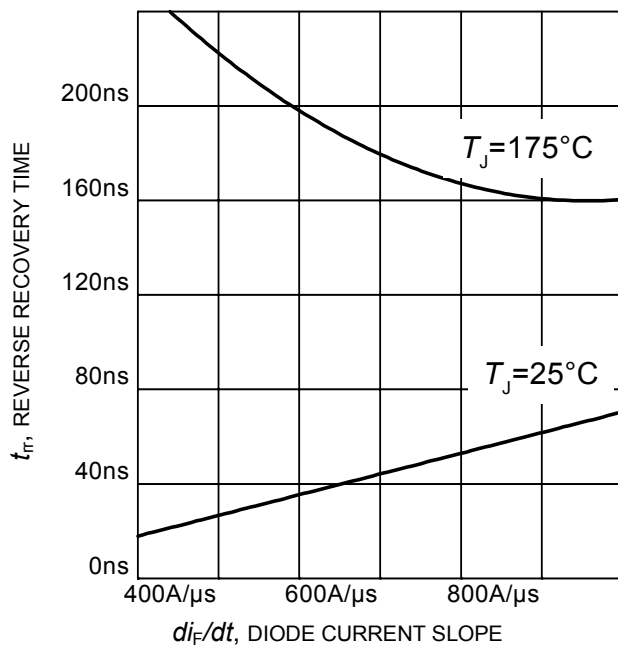
**Figure 20. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE}=600\text{V}$ , start at  $T_J=25^\circ\text{C}$ ,  $T_{Jmax}<150^\circ\text{C}$ )



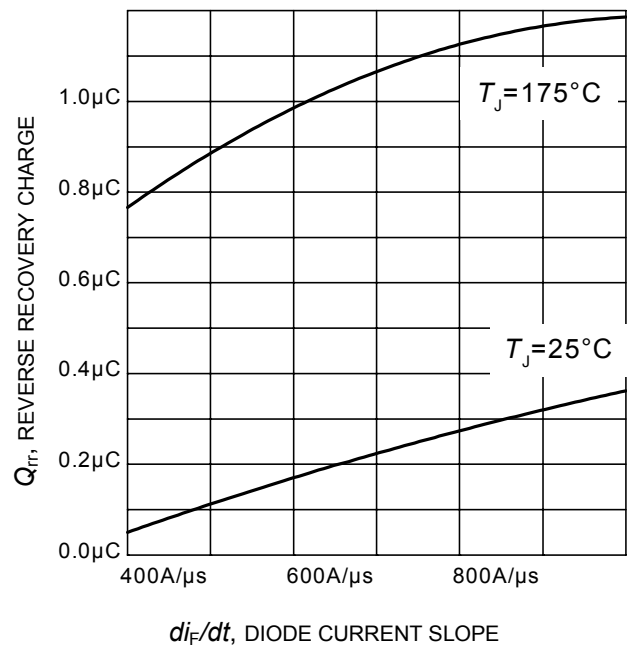
**Figure 21. IGBT transient thermal resistance**  
( $D = t_p / T$ )



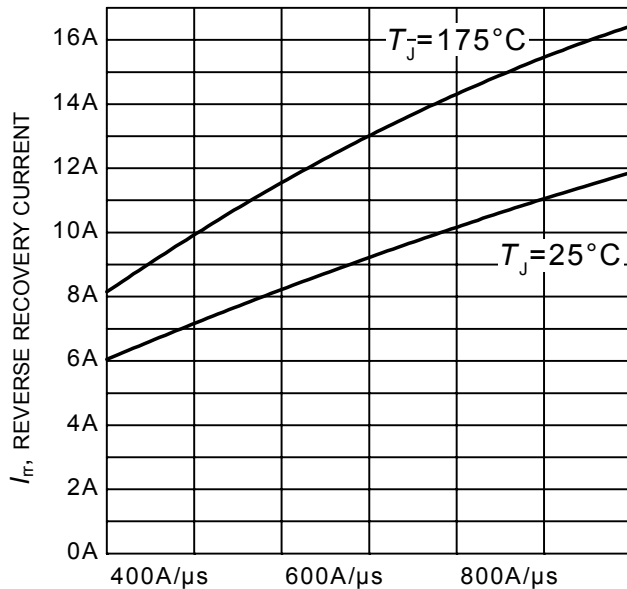
**Figure 22. Diode transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )



**Figure 23. Typical reverse recovery time as a function of diode current slope**  
( $V_R = 400V$ ,  $I_F = 15A$ ,  
Dynamic test circuit in Figure E)



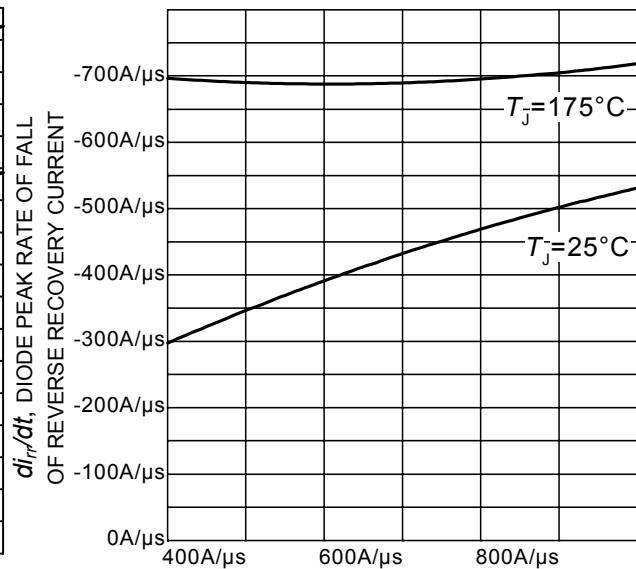
**Figure 24. Typical reverse recovery charge as a function of diode current slope**  
( $V_R = 400V$ ,  $I_F = 15A$ ,  
Dynamic test circuit in Figure E)



$di_F/dt$ , DIODE CURRENT SLOPE

**Figure 25. Typical reverse recovery current as a function of diode current slope**

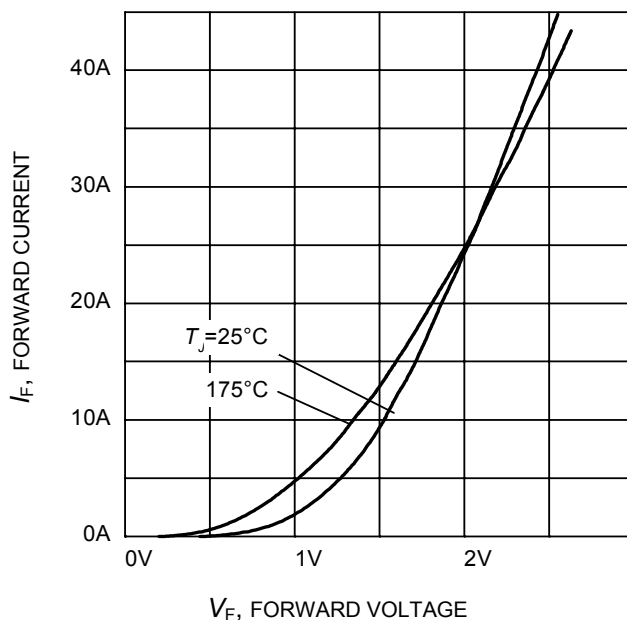
( $V_R = 400V$ ,  $I_F = 15A$ ,  
Dynamic test circuit in Figure E)



$di_F/dt$ , DIODE CURRENT SLOPE

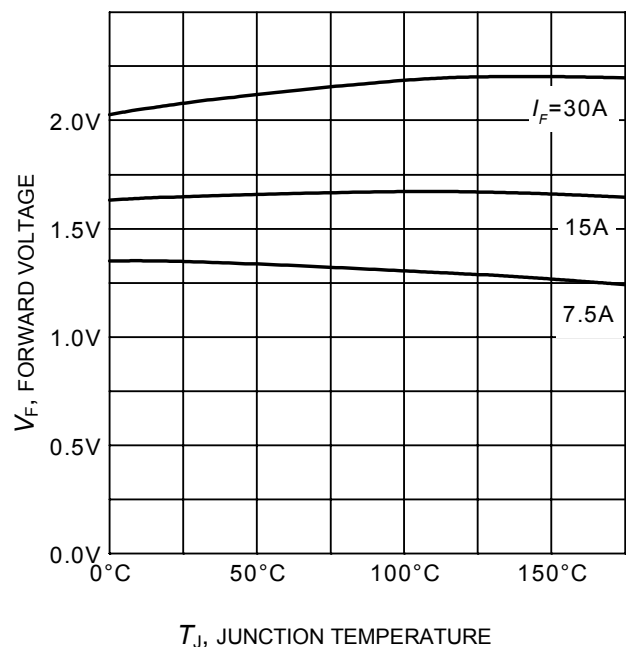
**Figure 26. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

( $V_R = 400V$ ,  $I_F = 15A$ ,  
Dynamic test circuit in Figure E)



$V_F$ , FORWARD VOLTAGE

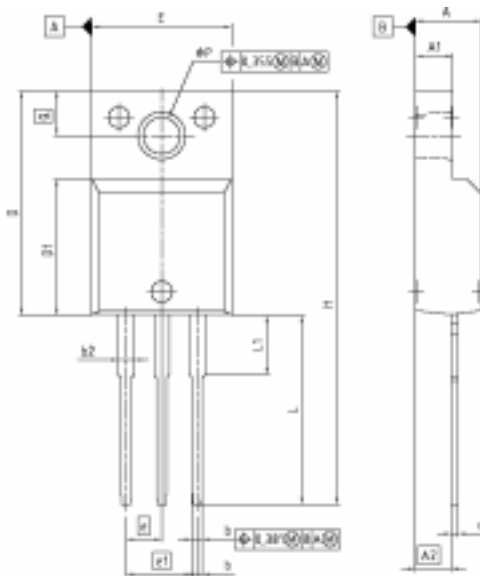
**Figure 27. Typical diode forward current as a function of forward voltage**



$T_J$ , JUNCTION TEMPERATURE

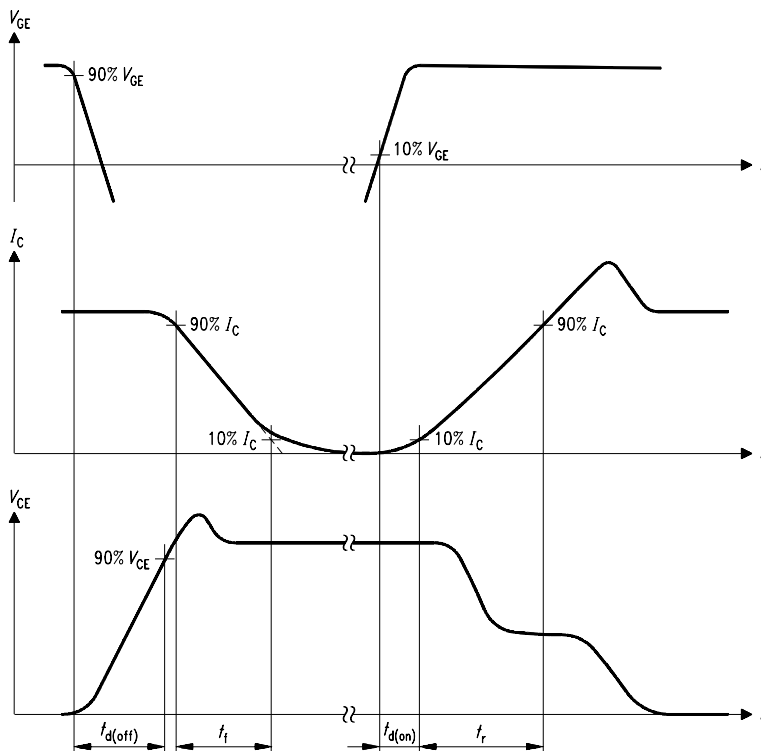
**Figure 28. Typical diode forward voltage as a function of junction temperature**

PG-TO220-3-31



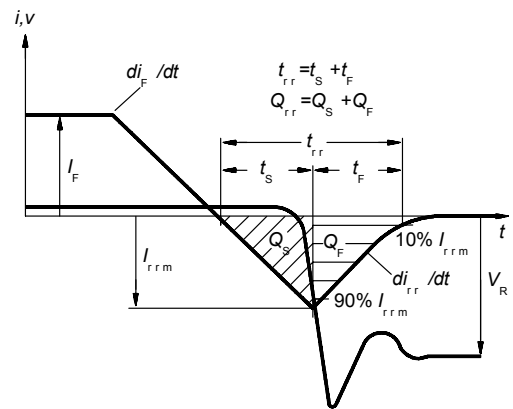
| DIM | MILLIMETERS |        | INCHES |       |
|-----|-------------|--------|--------|-------|
|     | MIN         | MAX    | MIN    | MAX   |
| A   | 4.672       | 4.826  | 0.180  | 0.190 |
| A1  | 2.573       | 2.827  | 0.101  | 0.111 |
| A2  | 2.514       | 2.616  | 0.099  | 0.103 |
| b   | 0.648       | 0.776  | 0.025  | 0.030 |
| b2  | 1.143       | 1.509  | 0.045  | 0.059 |
| e   | 0.449       | 0.527  | 0.017  | 0.027 |
| D   | 13.883      | 16.117 | 0.544  | 0.634 |
| D1  | 9.554       | 9.808  | 0.376  | 0.386 |
| E   | 10.373      | 10.627 | 0.408  | 0.418 |
| e1  | 2.540       |        | 0.100  |       |
| e1  | 3.080       |        | 0.200  |       |
| N   | 3           |        | 3      |       |
| H   | 29.463      | 29.717 | 1.160  | 1.170 |
| L   | 13.473      | 13.727 | 0.530  | 0.540 |
| L1  | 3.173       | 3.427  | 0.125  | 0.135 |
| eP  | 2.948       | 3.025  | 0.119  | 0.118 |
| Q   | 3.149       | 3.291  | 0.124  | 0.129 |

Please refer to mounting instructions

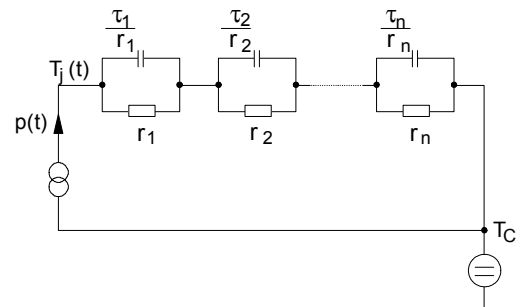


**Figure A. Definition of switching times**

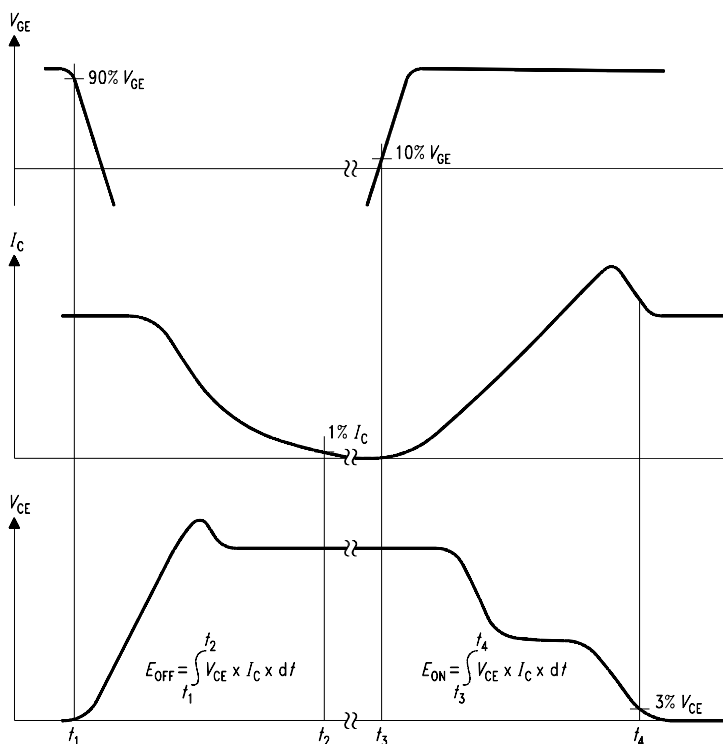
SIS00053



**Figure C. Definition of diodes switching characteristics**

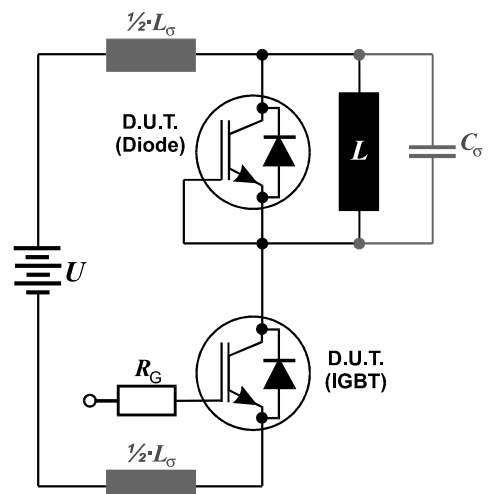


**Figure D. Thermal equivalent circuit**



**Figure B. Definition of switching losses**

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**Figure E. Dynamic test circuit**  
Leakage inductance  $L_{\sigma} = 60\text{nH}$   
and Stray capacity  $C_{\sigma} = 40\text{pF}$ .

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